EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L7	2	wafer and exposure and (acid with diffusion with dissolving)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/28 15:10
S1	10	substrate.clm. and exposure.clm. and acid.clm. and diffusion.clm. and dissolving.clm.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/28 00:09
S2		"118"/\$.ccls. and (pivotal with shift) and (exposure) and (acid with dissolving with diffusion)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2007/05/28 00:14
S3	0	"396"/\$.ccls. and (pivotal with shift) and (exposure) and (acid with dissolving with diffusion)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/27 23:57
S4	34	"396"/\$.ccls. and (pivotal with shift) and (exposure)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/27 23:58
S5	1	"118"/\$.ccls. and (pivotal with shift) and (exposure)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/28 00:09
S6	3	"430"/\$.ccls. and (pivotal with shift) and (exposure)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2007/05/27 23:58
S7	1	"438"/\$.ccls. and (pivotal with shift) and (exposure)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/27 23:58

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S8	0	"118"/\$.ccls. and (pivotal with shift) and (photoresist) and time and control	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/28 00:14
S9	3	(pivotal with shift) and (photoresist) and time and control	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/28 00:15
S10	18	(developing with time with control) and (photoresist) and "118"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/28 00:49
S11	14	(developing with time with control) and (correlation) and "118"/\$.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/28 00:59
S12	118	(118/698).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/28 01:00
S14	174	(118/699).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/28 01:11
S15	159	(118/682).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/28 01:12
S16	516	(118/665).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/28 01:12

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S17	90	(118/702).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF.	2007/05/28 01:12
S18	197	(118/704).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/28 01:31
S19	2	("6281145").PN.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/05/28 01:36
S21	5	(("6869234") or ("6749351") or ("6752544") or ("6656277") or ("6692165")).PN.	US-PGPUB; USPAT	OR	OFF	2007/05/28 01:40
S22	7	"substrate treating method and apparatus"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/05/28 01:41